InMates are an innovative solution for through-hole socket requirements. Consisting of individual plastic carriers for the input and the output, each contains an array of sockets for either a full-, half- or quarter-brick sized module. The sockets are factory loaded into the carrier, which holds them rigidly in place throughout the assembly and soldering process. The carriers are later removed, leaving the sockets accurately positioned.

Designed for use with pin-compatible Maxi, Mini and Micro Family converters, InMates are available for a wide range of PCB sizes and mounting styles. PCB thicknesses can range from 0.055in [1,39mm] to 0.1375in [3,49mm].

Sockets also allow for mounting modules either inboard, with a cutout in the PCB for the module, to minimize the height above the board or onboard. InMates are compatible with the ModuMate or RoHS pin style.

InMates are available in standard recyclable JEDEC style trays for use with automated pick-and-place equipment and are compatible with most standard wave or hand solder operations. The sockets are soldered into the board as part of the PCB assembly process. The module can then be plugged into place at anytime later.

NOTE: Please refer to <u>Section 13</u> of the design guide for the InMate soldering procedure.



Figure 16.1 — InMate carrier / socket assembly and soldering process



			InN	late: Thro	ugh-Hole S	Sockets					
1.	2.					3.			4.		5.
▼ Board Thickness	V	Fu	▼ Il Brick [Ma	xi)	На	▼ If Brick [Mi	ini)	Quar	▼ ter Brick [N	/licro)	•
Normal [Min / Max)	Mounting Style	Input	Output	Five Sets	Input	Output	Five Sets	Input	Output	Five Sets	Pin Style
0.062in (0.055in / 0.071in)	Inboard	18374	18382	18362	18374	18384	18366	18376	18386	18370	S or F
1,5mm (1,4mm / 1,8mm)	Onboard	18378	18388	18364	18378	18390	18368	18380	18392	18372	N or G
0.093in (0.084in / 0.104in)	Inboard	18375	18383	18363	18375	18385	18367	18377	18387	18371	S or F
2,4mm (2,1mm / 2,6mm)	Onboard	18379	18389	18365	18379	18391	18369	18381	18393	18373	N or G
0.125in (0.1125in / 0.1375in) 3,1mm (2,8mm / 3,5mm)	Onboard	21539	21543	21510	21539	21544	21511	21540	21545	21512	N or G

Table 16.1 — Guide to InMate selection

1. Select Board Thickness:

Nominal 0.062in [1,5mm], 0.093in [2,4mm] or 0.125in [3,1mm].

2. Select Mounting Style:

Inboard requires a PCB cutout for the "belly" of the module. See dotted lines in PCB drawing links on Page 80 for cut-out area.

3. Identify Module Type:

Full brick (Maxi), half brick (Mini) or quarter brick (Micro).

4. Select the Ordering Part Number:

Order packages of five input / output sets or in higher quantities order input and output InMates separately. For individual input or output InMates, minimum orders of 35 for Maxi or Mini and 40 for Micro apply.

5. Verify Correct Pin Style for the Module:

For predefined parts, "S" or "F"= short ModuMate and "N" or "G" = long ModuMate

See Table 16.4 for standoff recommendations.



Parameter	Specification Value	Reference		
Compatibility				
	F = short Au plated	Short RoHS pins		
Madula Dia Stulas	S = short Au plated	Short ModuMate pins		
Module Pin Styles	G = long Au plated	Long RoHS pins		
	N = long Au plated	Long ModuMate pins		
Mechanical				
Contact Normal Force	100g EOL min	GR-1217-CORE, R5-23		
Number of Mating Cycles	5 max ^[h]	Exception to GR-1217-CORE which specifies 25 mating cycle		
Module Engagement Force	32lbs per connector set max	GR-1217-CORE, R5-31,32		
Module Disengagement Force	32lbs per connector set max	GR-1217-CORE, R5-31,32		
Electrical				
Current Rating for Output Pin Sockets	50A Maxi ^{le]} / 50A Mini / 25A Micro (Based on 248°F [120°C] max socket temp & 86°F [30°C] max temperature rise of contact)	Gold plating standards and accepted industry standards such as IICIT, EIA, Bellcore guidelines		
Low-Level Contact Resistance 0.080in [2,03mm] dia socket (LLCR)	400μΩ max	GR-1217-CORE, 6.2.1		
Low-Level Contact Resistance 0.150in [3,81mm] dia socket (LLCR)	300μΩ max	GR-1217-CORE, 6.2.1		
Low-Level Contact Resistance 0.180in [4,57mm] dia sockets (LLCR)	200μΩ max	GR-1217-CORE, 6.2.1		
Thermal				
Max Socket Temperature	248°F [120°C] max	Max continuous-use temperature for gold plating		
Temperature Rise	86°F [30°C] max	GR-1217-CORE ^[g] EIA-364-70A ^[f]		
Environmental				
Shock and Vibration	and amplitudes that may be encountered in typical a	ronments to best simulate the broad spectrum of frequencies applications. Actual system resonant frequencies will depend on r unusual shock and vibration environments, the performance		

Table 16.2 — InMate specifications and materials

Materials	Ratings
Headers	
Material: Ryton™ R–7 PPS, 65% Glass Fiber and Mineral-Filled Compound	Poly-Phenylene Sulfide
Flammability	UL94 V-0/5VA
Thermal Stability (short term)	500°F [260°C]
Thermal Stability (long term)	392°F [200°C]
Solder Cap	
Material	305 stainless steel
Plating	Clear passivate to repel solder
Sockets	
Material	Brush Wellman Alloy #25 C17200 deep draw quality or equiv. 0.010in thick
Plating	Woods nickel strike followed by 50µin min low stress sulfamate-based electrolytic nickel, followed by 20µin min hard gold, followed by 10µin min soft gold

Table 16.3 — Material properties of InMate components

^[e] For 80A operation with Maxi, contact Applications Engineering.

[f] GR-1217-CORE issue 1, November 1995 Generic requirements for separable electrical connectors used in telecommunications hardware. A module of NEBSFR, FR-2063

^[g] ANSI/EIA-364 American National Standards Institute / Electronic Industries Association (Electronic Components, Assemblies & Materials Association)

^[h] The module and socket must be replaced after five mating cycles.



		Standorr Kits	for InMate Mounted	modules		1	
Board Thickness	Mounting Options		tted plate	Througl Basep		Threaded Baseplate	
Nominal (Min / Max]	Mounting Style	Through-Hole Heat Sink	Threaded Heat Sink	Through-Hole Heat Sink	Threaded Heat Sink	Through-Hole Heat Sink	
0.002	la la a and	Kit -18153	Kit -18154	Kit -18148	Kit -18149	Kit -18148	
0.062in (0.055in / 0.071in)	Inboard	Bag -19129	Bag -19130	Bag -19124	Bag -19125	Bag -19124	
1,5mm		Kit -18158	Kit -18159	Kit -18153	Kit -18155	Kit -18153	
(1,4mm /1,8mm)	Onboard	Bag -19134	Bag -19135	Bag -19129	Bag -19131	Bag -19129	
0.002	to be a set	Kit -18153	Kit -18154	Kit -18148	Kit -18149	Kit -18148	
0.093in (0.084in / 0.104in)	Inboard	Bag -19129	Bag -19130	Bag -19124	Bag -19125	Bag -19124	
2,4mm	Orala a sural	Kit -18156	Kit -18157	Kit -18150	Kit -18152	Kit -18150	
(2,1mm /2,6mm)	Onboard	Bag -19132	Bag -19133	Bag -19126	Bag -19128	Bag -19126	
0.125in (0.113in / 0.138in)	Ophoard	Kit - 24054	Kit -18157	Kit -24056	Kit - 18152	Kit-24056	
3,1mm (2,8mm / 3,5mm)	Onboard	Bag -19132	Bag -19133	Bag -19126	Bag - 19128	Bag-19126	

Kits include six (6] standoffs and screws. Mini and Micro modules require a minimum of four (4] standoffs. Bags of one hundred (100] do not include screws; #4-40 thread hardware required.

Table 16.4 — InMate standoff recommendations

References

InMate PCB layout drawing for Maxi Module InMate PCB layout drawing for Mini Module InMate PCB layout drawing for Micro Module InMate and Socket outline drawing for Inboard Maxi Modules InMate and Socket outline drawing for Inboard Micro Modules InMate and Socket outline drawing for Onboard Maxi Modules InMate and Socket outline drawing for Onboard Maxi Modules InMate and Socket outline drawing for Onboard Mini Modules InMate and Socket outline drawing for Onboard Mini Modules

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	Module Exchange Tool
	extraction of modules from InMate or SurfMate sockets. Exchange Tool may cause damage to the sockets.
Description	Part Number
Maxi Exchange Tool	22827
Mini Exchange Tool	22828
Micro Exchange Tool	22829

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